



**WANSEMI**  
万芯半导体

**WX041N03PA**

# **Enhancement Mode N-Channel Power MOSFET**

PDFN5X6/NMOS/30V/ $\pm 20$ V/1.65V/80A/4.1m $\Omega$

Rev0.1

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## 30V, 4.1mΩ, 80A, N-Channel Enhancement MOSFET

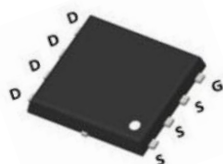
### 1.Features

- ◆ 30V MOSFET technology
- ◆ Low on-state resistance
- ◆ Fast switching
- ◆  $V_{GS} \pm 20V$
- ◆ 100% RG Tested
- ◆ 100% UIS Tested

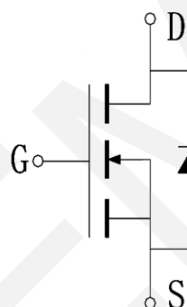
$V_{DS}$	$R_{DS(on)}$ Typ.	$I_D$ Max.
30V	4.1mΩ @ 10V	80A
	5.5mΩ @ 4.5V	

### 2.Applications

- ◆ Power Switching Application
- ◆ Load Switching



PDFN5X6  
Pin Description



Schematic Diagram

### 3.Package Marking and Ordering Information

Part no.	Marking	Package	PCS/Reel	PCS/CTN.
WX041N03PA	041N03	PDFN5X6	5,000	50,000

### 4.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	$V_{DSS}$	30	V
Gate to Source Voltage	$V_{GSS}$	$\pm 20$	V
Drain Current (DC)	$I_D$	80	A
Drain Current (Pulse), $PW \leq 300\mu s$	$I_{DP}$	320	A
Total Dissipation	$P_D$	81	W
Avalanche Energy, Single Pulsed	$E_{AS}$	96	mJ
Junction Temperature	$T_j$	150	°C
Storage Temperature	$T_{stg}$	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

## 5. Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Junction to Case	$R_{\theta JC}$	1.5	$^{\circ}\text{C/W}$

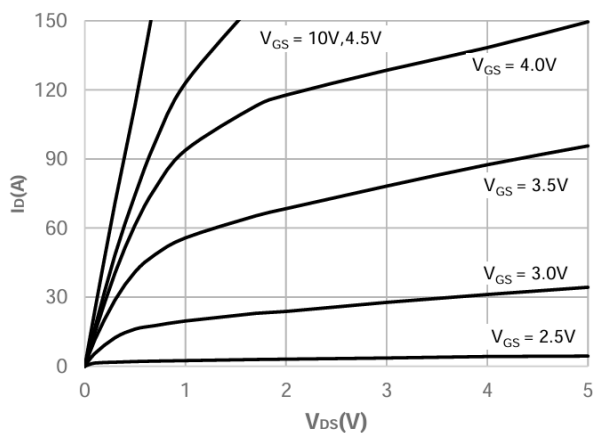
Note 2: When mounted on 1 inch square copper board  $t \leq 10\text{sec}$  The value in any given application depends on the user's specific board design.

## 6. Electrical Characteristics at $T_a=25^{\circ}\text{C}$ (Note 3)

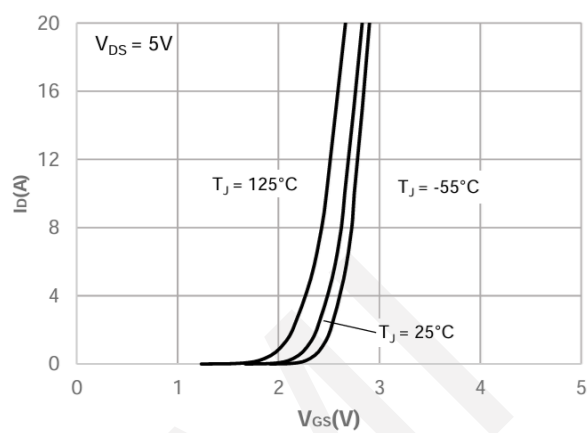
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Units
Drain to Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 250\mu\text{A}$ , $V_{GS} = 0\text{V}$	30	-	-	V
Zero-Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 30\text{V}$ , $V_{GS} = 0\text{V}$	-	-	1	$\mu\text{A}$
Gate to Source Leakage Current	$I_{GSS}$	$V_{GS} = \pm 20\text{V}$ , $V_{DS} = 0\text{V}$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_{DS} = 250\mu\text{A}$	1.2	1.65	2.3	V
Static Drain to Source On-State Resistance	$R_{DS(on)}$	$I_D = 30\text{A}$ , $V_{GS} = 10\text{V}$	-	4.1	5.2	$\text{m}\Omega$
		$I_D = 20\text{A}$ , $V_{GS} = 4.5\text{V}$	-	5.5	7.0	$\text{m}\Omega$
Input Capacitance	$C_{iss}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 15\text{V}$ , Frequency = 1.0MHz	-	2247	-	pF
Output Capacitance	$C_{oss}$		-	264	-	pF
Reverse Transfer Capacitance	$C_{rss}$		-	220	-	pF
Turn-ON Delay Time	$t_{d(on)}$	$V_{DD} = 15\text{V}$ , $V_{GS} = 10\text{V}$ , $R_{GEN} = 3\Omega$ , $I_D = 30\text{A}$	-	8	-	ns
Rise Time	$t_r$		-	16	-	ns
Turn-OFF Delay Time	$t_{d(off)}$		-	40	-	ns
Fall Time	$t_f$		-	13	-	ns
Total Gate Charge	$Q_g$	$V_{DS} = 15\text{V}$ , $V_{GS} = 0 \text{ to } 10\text{V}$ , $I_D = 30\text{A}$	-	45	-	nC
	$Q_{gs}$		-	8	-	nC
	$Q_{gd}$		-	10	-	nC
Diode Forward Voltage	$V_{FSD}$	$I_S = 30\text{A}$ , $V_{GS} = 0$	-	-	1.2	V

Note 3: Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

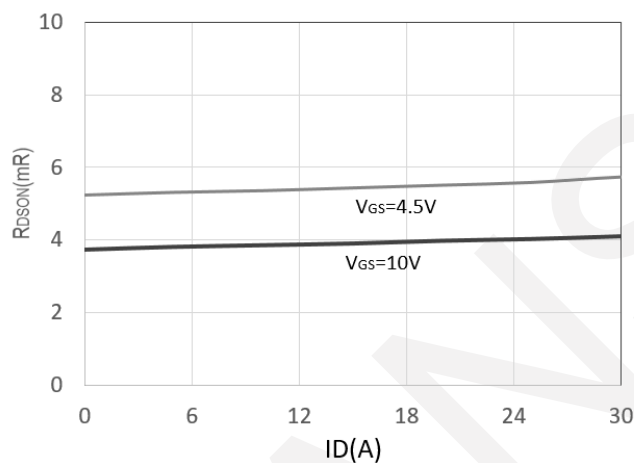
## 7. Typical electrical and thermal characteristics



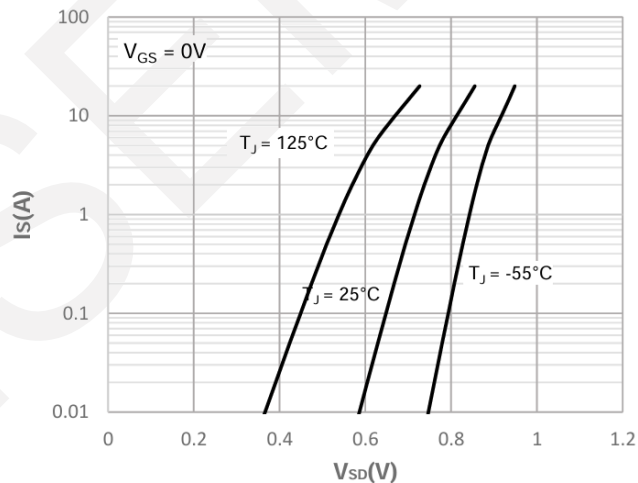
Output Characteristics



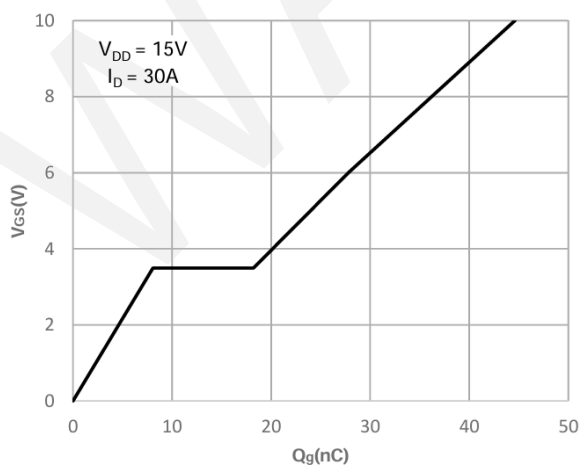
Typical Transfer Characteristics



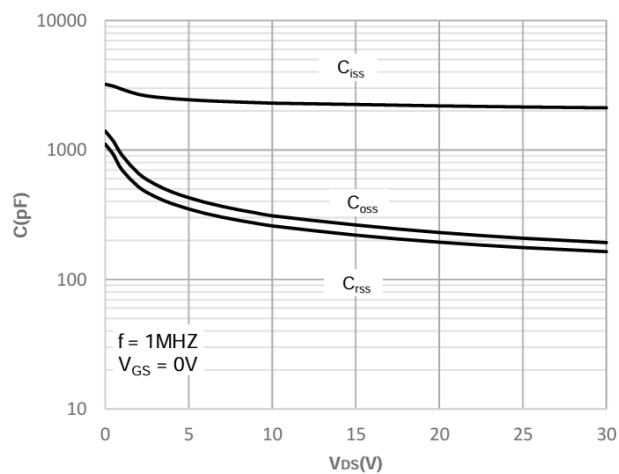
On-resistance vs. Drain Current



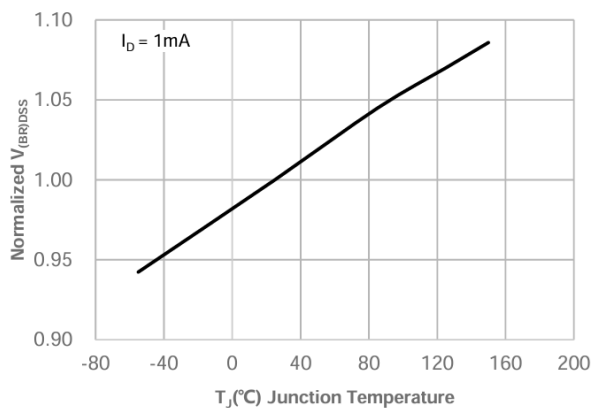
Body Diode Characteristics



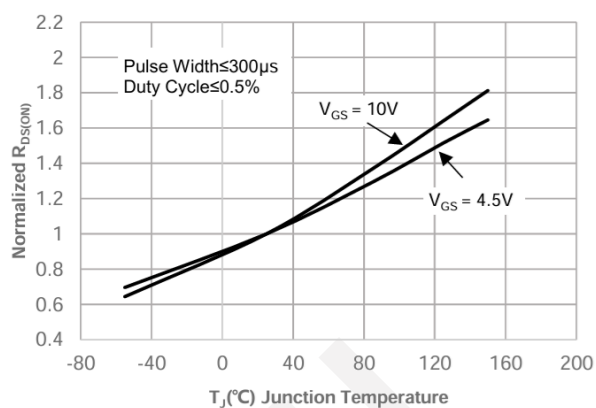
Gate Charge Characteristics



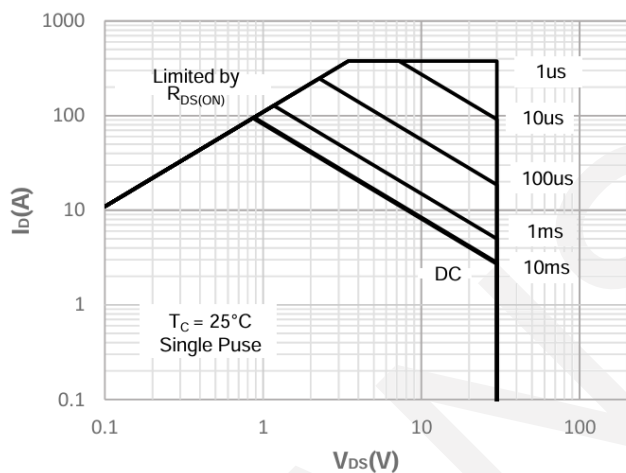
Capacitance Characteristics



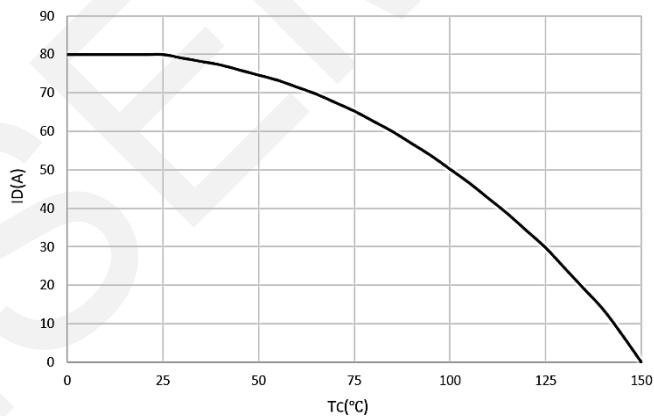
Normalized Breakdown voltage vs. Junction Temperature



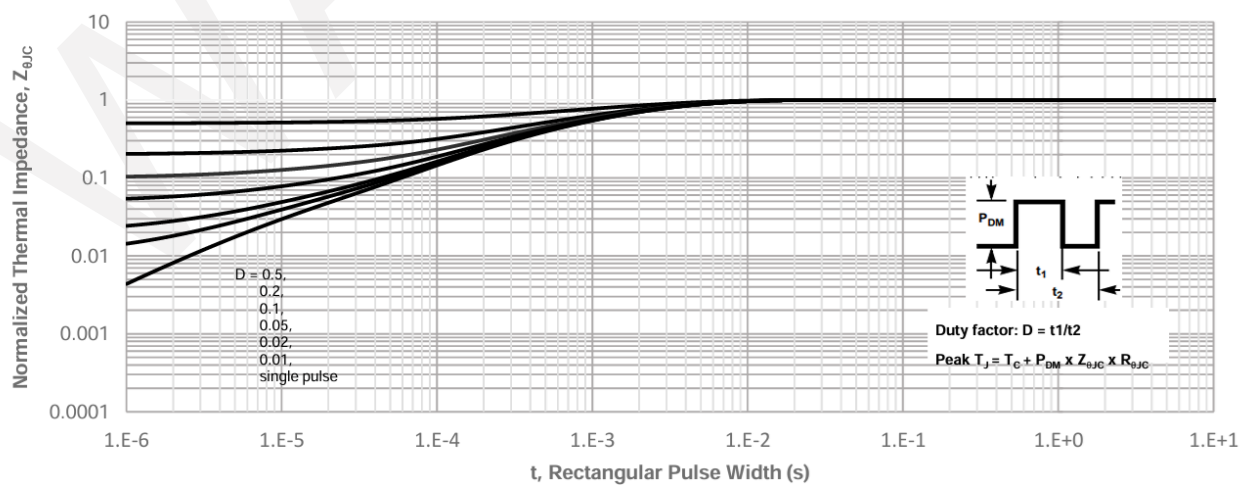
Normalized on Resistance vs. Junction Temperature



Maximum Safe Operating Area

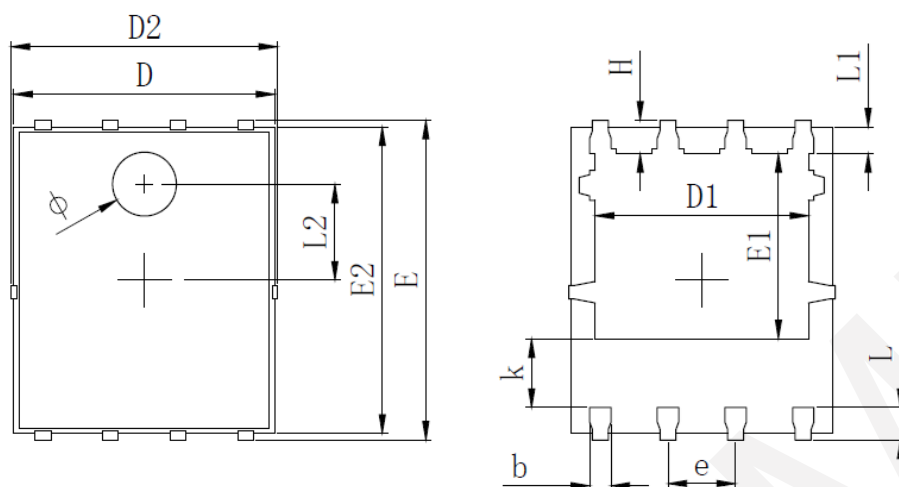


Maximum Continuous Drain Current vs. Case Temperature



Maximum Effective Transient Thermal Impedance, Junction-to-Case

## 8.Package Dimensions



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	0.900	1.000	1.100
A1	0.254 REF.		
A2	0~0.05		
D	4.824	4.900	4.976
D1	3.910	4.010	4.110
D2	4.924	5.000	5.076
E	5.924	6.000	6.076
E1	3.375	3.475	3.575
E2	5.674	5.750	5.826
b	0.350	0.400	0.450
e	1.270 TYP.		
L	0.534	0.610	0.686
L1	0.424	0.500	0.576
L2	1.800 REF.		
k	1.190	1.290	1.390
H	0.549	0.625	0.701
θ	8°	10°	12°
φ	1.100	1.200	1.300
d			0.100

## 9. Important Notice

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